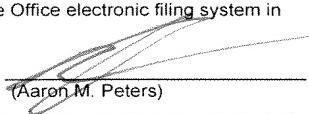


I hereby certify that this paper (along with any paper referred to as being attached or enclosed) is being transmitted via the Office electronic filing system in accordance with § 1.6(a)(4).

Dated: May 27, 2008

Signature:



(Aaron M. Peters)

Docket No.: 29347/990488
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Gi-Young JEUN et al.

Application No.: 09/677,558

Confirmation No.: 1618

Filed: September 29, 2000

Art Unit: 2814

For: SEMICONDUCTOR POWER MODULE
HAVING AN ELECTRICALLY INSULATING
HEAT SINK AND METHOD OF
MANUFACTURING THE SAME

Examiner: D. P. NGUYEN

AMENDMENT "K" AND RESPONSE TO OFFICIAL ACTION DATED JANUARY 18, 2008 WITH REQUEST FOR CONTINUED EXAMINATION

MS RCE
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

INTRODUCTORY COMMENTS

In response to the non-final official action dated January 18, 2008, the applicants respectfully request that the application be reconsidered in light of the following amendments and/or remarks.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 4 of this paper.